MOSFET – Dual, P-Channel with ESD Protection, Small Signal, SOT-563

-20 V, -430 mA

Features

- Low R_{DS(on)} Improving System Efficiency
- Low Threshold Voltage
- ESD Protected Gate
- Small Footprint 1.6 x 1.6 mm
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- Load/Power Switches
- Power Supply Converter Circuits
- Battery Management
- Cell Phones, Digital Cameras, PDAs, Pagers, etc.

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted.)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	-20	V
Gate-to-Source Voltage			V _{GS}	±6.0	V
Continuous Drain Current	Steady	$T_A = 25^{\circ}C$	I_	-430	mA
(Note 1)	State	T _A = 85°C	I _D	-310	
Power Dissipation (Note 1)	Steady State		P _D	250	mW
Continuous Drain Current	t ≤ 5 s	$T_A = 25^{\circ}C$	l_	-455	mA
(Note 1)	1 2 3 3	$T_A = 85^{\circ}C$	I _D	-328	
Power Dissipation (Note 1)	t ≤ 5 s		P _D	280	mW
Pulsed Drain Current	t _p =	10 μs	I_{DM}	-750	mA
Operating Junction and Storage Temperature			T _J , T _{STG}	-55 to 150	°C
Source Current (Body Diode)			Is	-350	mA
Lead Temperature for Sold (1/8" from case for 10 s		oses	T _L	260	°C

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Max	Unit
Junction-to-Ambient - Steady State (Note 1)			°C/W
Junction–to–Ambient – t ≤ 5 s (Note 1)	$R_{\theta JA}$	447	1

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

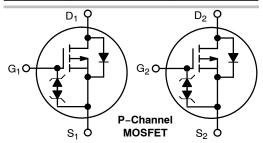
 Surface mounted on FR4 board using 1 in. sq. pad size (Cu. area = 1.127 in. sq. [1 oz.] including traces).



ON Semiconductor®

www.onsemi.com

V _{(BR)DSS} R _{DS(on)} Typ		I _D Max
	0.5 Ω @ -4.5 V	
-20 V	0.6 Ω @ -2.5 V	–430 mA
	1.0 Ω @ -1.8 V	



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MARKING DIAGRAM

SOT-563-6 CASE 463A

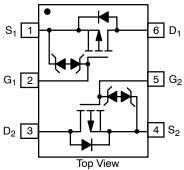


TU = Specific Device Code

M = Date Code

■ Pb-Free Package
(Note: Microdot may be in either location)

PINOUT: SOT-563



ORDERING INFORMATION

Device	Package	Shipping [†]
NTZD3152PT1G	SOT-563	4000 / Tone 9 Dool
NTZD3152PT1H	(Pb-Free)	4000 / Tape & Reel
NTZD3152PT5H	SOT-563 (Pb-Free)	8000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted.)

V _{(BR)DSS}					1	
	\/ 0\/ I					
	$v_{GS} = v_{S} v_{S}$	= -250 μΑ	-20			V
V _{(BR)DSS} /T _J				18		mV/°C
I _{DSS}	V _{GS} = 0 V,	T _J = 25°C			-1.0	μΑ
	$V_{DS} = -16 \text{ V}$	T _J = 125°C			-2.0	1
I _{GSS}	V _{DS} = 0 V, V _{GS}	s = ±4.5 V			±2.0	μΑ
V _{GS(TH)}	$V_{GS} = V_{DS}, I_{D}$	= -250 μA	-0.45		-1.0	V
V _{GS(TH)} /T _J				-1.9		mV/°C
R _{DS(on)}	V _{GS} = -4.5 V, I _E	₀ = -430 mA		0.5	0.9	Ω
	V _{GS} = -2.5 V, I _E	₀ = -300 mA		0.6	1.2	1
	V _{GS} = -1.8 V, I _E	₀ = -150 mA		1.0	2.0	1
9FS	$V_{DS} = -10 \text{ V}, \text{ I}_{D}$	= -430 mA		1.0		S
C _{ISS}	$V_{GS} = 0 \text{ V, f} = 1.0 \text{ MHz,}$ $V_{DS} = -16 \text{ V}$			105	175	pF
C _{OSS}				15	30	1
C _{RSS}				10	20	1
Q _{G(TOT)}				1.7	2.5	nC
Q _{G(TH)}	V _{GS} = -4.5 V, V	ns = -10 V,		0.1		1
Q_{GS}	I _D = -21	5 mA		0.3		1
Q_{GD}				0.4		1
e 3)						
t _{d(on)}				10		ns
t _r	V _{GS} = -4.5 V. V	_{DD} = -10 V,		12		1
t _{d(off)}	$I_{D} = -215 \text{ mA},$	$R_G = 10 \Omega$		35		1
t _f				19		1
ISTICS						
V _{SD}	$V_{GS} = 0 \text{ V},$ $I_{S} = -350 \text{ mA}$	T _J = 25°C		-0.8	-1.2	V
t _{RR}				13		ns
	VGS(TH) VGS(TH)/TJ RDS(on) GFS COSS CRSS QG(TOT) QG(TH) QGS QGD dd(on) tr td(off) tf ISTICS VSD VSD VSD VSD VSD VSS VS	V _{DS} = -16 V I _{GSS}	$V_{DS} = -16 \text{ V} \qquad T_{J} = 125^{\circ}\text{C}$ $I_{GSS} \qquad V_{DS} = 0 \text{ V, } V_{GS} = \pm 4.5 \text{ V}$ $V_{GS(TH)} \qquad V_{GS} = V_{DS}, I_{D} = -250 \mu\text{A}$ $V_{GS(TH)}/T_{J} \qquad V_{GS} = -4.5 \text{V, } I_{D} = -430 \text{mA}$ $V_{GS} = -2.5 \text{V, } I_{D} = -300 \text{mA}$ $V_{GS} = -1.8 \text{V, } I_{D} = -150 \text{mA}$ $V_{GS} = -1.8 \text{V, } I_{D} = -150 \text{mA}$ $V_{GS} = -10 \text{V, } I_{D} = -430 \text{mA}$ $V_{GS} = -10 \text{V, } I_{D} = -430 \text{mA}$ $V_{GS} = -10 \text{V, } I_{D} = -430 \text{mA}$ $V_{GS} = -10 \text{V, } I_{D} = -430 \text{mA}$ $V_{GS} = -10 \text{V, } I_{D} = -10 \text{V, } I_{D} = -16 \text{V}$ $V_{GS} = -16 \text{V}$ $V_{GS} = -4.5 \text{V, } V_{DS} = -10 \text{V, } I_{D} = -215 \text{mA}$ $V_{GS} = -4.5 \text{V, } V_{DD} = -10 \text{V, } I_{D} = -215 \text{mA}$ $V_{GS} = -4.5 \text{V, } V_{DD} = -10 \text{V, } I_{D} = -215 \text{mA}$ $V_{GS} = -4.5 \text{V, } V_{DD} = -10 \text{V, } I_{D} = -215 \text{mA}$ $V_{GS} = -350 \text{mA}$ $V_{GS} = -350 \text{mA}$ $V_{GS} = -350 \text{mA}$	$V_{DS} = -16 \text{ V} \qquad T_{J} = 125^{\circ}\text{C}$ $I_{GSS} \qquad V_{DS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$ $V_{GS(TH)} \qquad V_{GS} = V_{DS}, I_{D} = -250 \mu\text{A} \qquad -0.45$ $V_{GS(TH)}/T_{J} \qquad V_{GS} = -4.5 \text{ V}, I_{D} = -430 \text{mA}$ $V_{GS} = -2.5 \text{ V}, I_{D} = -300 \text{mA}$ $V_{GS} = -1.8 \text{ V}, I_{D} = -150 \text{mA}$ $Q_{GS} = -1.8 \text{ V}, I_{D} = -430 \text{mA}$ $V_{DS} = -10 \text{ V}, I_{D} = -430 \text{mA}$ $V_{DS} = -16 \text{ V}$ $V_{DS} = -10 \text{ V}, I_{D} = -10 \text{ V}, I_{D} = -215 \text{mA}$ $V_{DS} = -215 \text{mA}$ $V_{DS} = -215 \text{mA}, R_{G} = 10 \Omega$ $V_{DS} = -215 \text{mA}, R_{G} = 10 \Omega$ $V_{DS} = -350 \text{mA}$ $V_{DS} = -350 \text{mA}$ $V_{DS} = 0 \text{ V}, I_{D} = -25^{\circ}\text{C}$ $V_{DS} = -350 \text{mA}$ $V_{DS} = 0 \text{ V}, I_{D} = -25^{\circ}\text{C}$	$V_{DS} = -16 \ V \qquad T_{J} = 125^{\circ}C \qquad T_{J} = 125$	$\begin{array}{ c c c c c } \hline V_{DS} = -16 \ V \\ \hline V_{DS} = -16 \ V \\ \hline V_{DS} = -16 \ V \\ \hline V_{DS} = 0 \ V, V_{GS} = \pm 4.5 \ V \\ \hline \hline V_{GS(TH)} \\ \hline V_{GS(TH)} \\ \hline V_{GS} = V_{DS}, I_{D} = -250 \ \mu A \\ \hline V_{GS(TH)}/T_{J} \\ \hline \\ \hline R_{DS(on)} \\ \hline V_{GS} = -4.5 \ V, I_{D} = -430 \ mA \\ \hline V_{GS} = -2.5 \ V, I_{D} = -300 \ mA \\ \hline V_{GS} = -1.8 \ V, I_{D} = -150 \ mA \\ \hline \\ \hline C_{DS} \\ \hline C_{DS} \\ \hline C_{RS} \\ \hline \\ \hline C_{GS} \\ \hline \\ \hline \\ \hline C_{GS} \\ \hline \\ $

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 2. Pulse Test: pulse width $\leq 300~\mu s$, duty cycle $\leq 2\%$. 3. Switching characteristics are independent of operating junction temperatures.

TYPICAL PERFORMANCE CURVES (T $_{J}$ = 25°C unless otherwise noted)

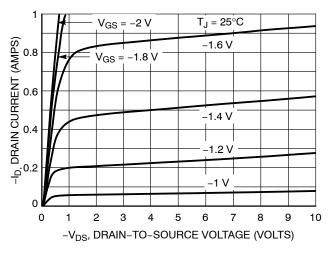


Figure 1. On-Region Characteristics

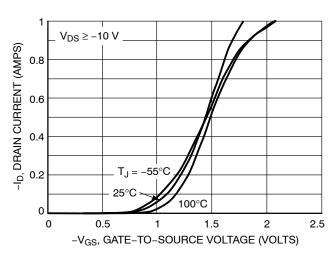


Figure 2. Transfer Characteristics

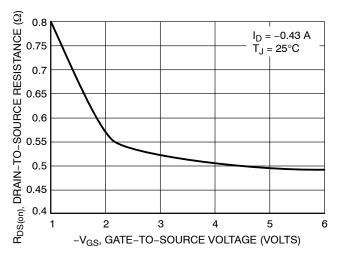


Figure 3. On-Resistance vs. Gate-to-Source Voltage

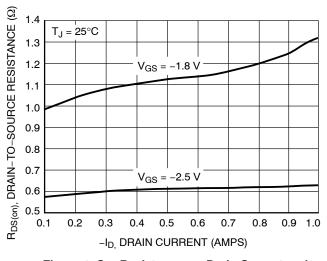


Figure 4. On-Resistance vs. Drain Current and Gate Voltage

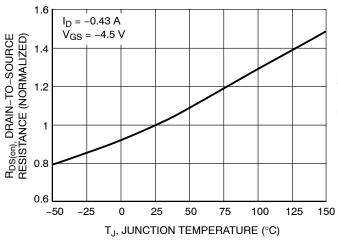


Figure 5. On–Resistance Variation with Temperature

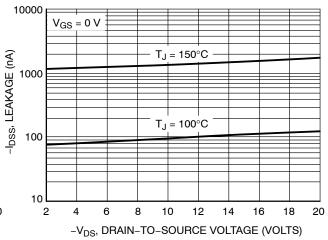


Figure 6. Drain-to-Source Leakage Current vs. Voltage

TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)

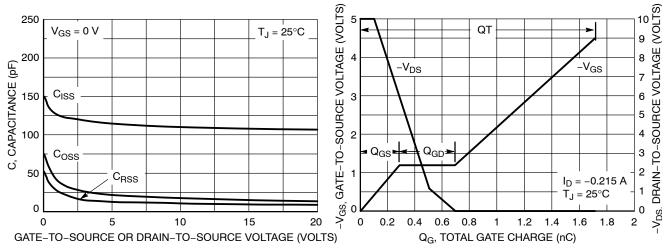


Figure 7. Capacitance Variation

Figure 8. Gate-to-Source and Drain-to-Source Voltage vs. Total Charge

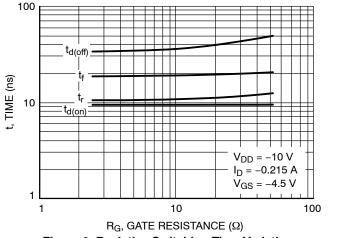


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

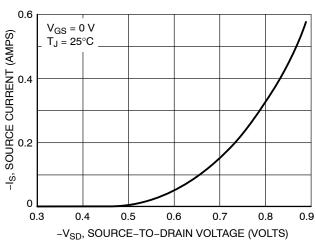


Figure 10. Diode Forward Voltage vs. Current

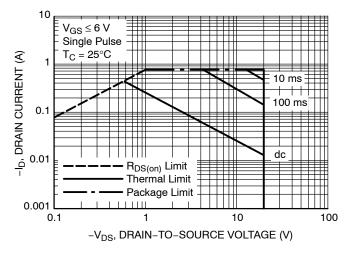


Figure 11. Safe Operating Area



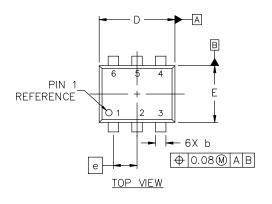


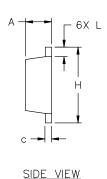
SOT-563-6 1.60x1.20x0.55, 0.50P CASE 463A **ISSUE J**

DATE 15 FEB 2024

NOTES:

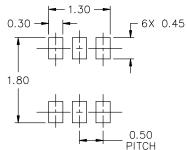
- 1. DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5-2018.
- ALL DIMENSION ARE IN MILLIMETERS.
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.





DIM	M.	ILLIMETE	-K2
ابالط	MIN.	N□M.	MAX.
Α	0.50	0.55	0.60
b	0.17	0.22	0.27
С	0.08	0.13	0.18
D	1,50	1.60	1.70
E	1.10	1,20	1.30
е		0.50 BSC	
Н	1.50	1.60	1.70
L	0.10	0.20	0.30

MILL IMETERS



STYLE 1: PIN 1. EMITTER 1 2. BASE 1 3. COLLECTOR 2 4. EMITTER 2 5. BASE 2 6. COLLECTOR 1	STYLE 2: PIN 1. EMITTER 1 2. EMITTER 2 3. BASE 2 4. COLLECTOR 2 5. BASE 1	STYLE 3: PIN 1. CATHODE 1 2. CATHODE 1 3. ANODE/ANODE 2 4. CATHODE 2 5. CATHODE 2 6. ANODE/ANODE 1
6. COLLECTOR 1	6. COLLECTOR 1	6. ANDDE/ANDDE 1

RECOMMENDED	MOUNTING	FOOTPRINT*

FOR ADDITIONAL INFORMATION ON OUR Pb-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

0714 5 7	0714 5 0	07.4 5 0
STYLE 7:	STYLE 8:	STYLE 9:
PIN 1. CATHODE	PIN 1. DRAIN	PIN 1. SOURCE 1
2. ANODE	2. DRAIN	2. GATE 1
3. CATHODE	3. GATE	3. DRAIN 2
4. CATHODE	4. SOURCE	4. SOURCE 2
5. ANDDE	5. DRAIN	5. GATE 2
6. CATH□DE	6. DRAIN	6. DRAIN 1

PIN 1. EMITTER 2

STYLE 11:

3. ANDDE

4. ANDDE 5. CATHODE

6. CATHODE

STYLE 5: PIN 1. CATHODE 2. CATHODE

GENERIC MARKING DIAGRAM*



XX = Specific Device Code M = Month Code = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking.

2. N/C	2.	BASE 2
3. CATHODE	2 3.	COLLECTOR
4. AN□DE 2	4.	EMITTER 1
5. N/C	5.	BASE 1
6. AN□DE 1	6.	COLLECTOR

STYLE 4: PIN 1. COLLECTOR 2. COLLECTOR

3. BASE

STYLE 10:

PIN 1. CATHODE 1

4. EMITTER
5. COLLECTOR
6. COLLECTOR

1 Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking. 2

STYLE 6: PIN 1. CATHODE 2. ANODE

3. CATHODE

4. CATHODE 5. CATHODE

CATHODE

DOCUMENT NUMBER:	98AON11126D	D COPY" in red.	
DESCRIPTION:	SOT-563-6 1.60x1.20x0.55	5, 0.50P	PAGE 1 OF 1

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